

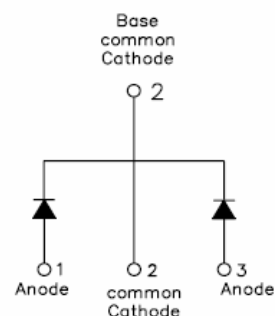
## MUR1620CT ULTRAFAST PLASTIC RECTIFIER

### Applications:

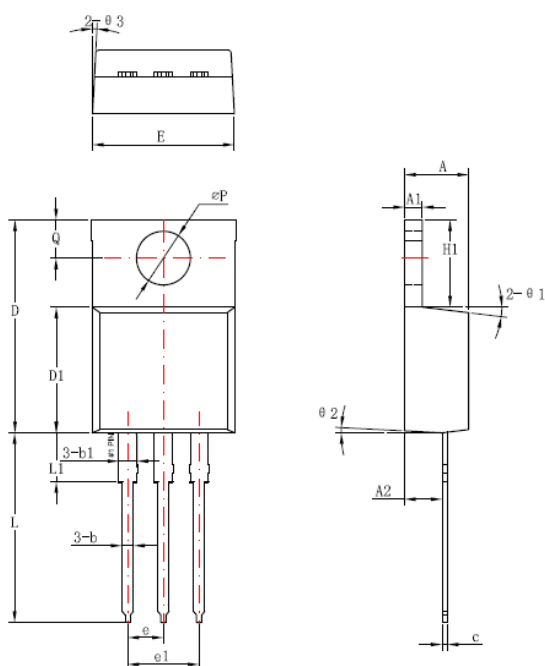
- Switching Power Supply
- Power Switching Circuits
- General Purpose

### Features:

- Ultra-Fast Switching
- High Current Capability
- Low Reverse Leakage Current
- High Surge Current Capability
- Plastic Material has UL Flammability Classification 94V-0
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

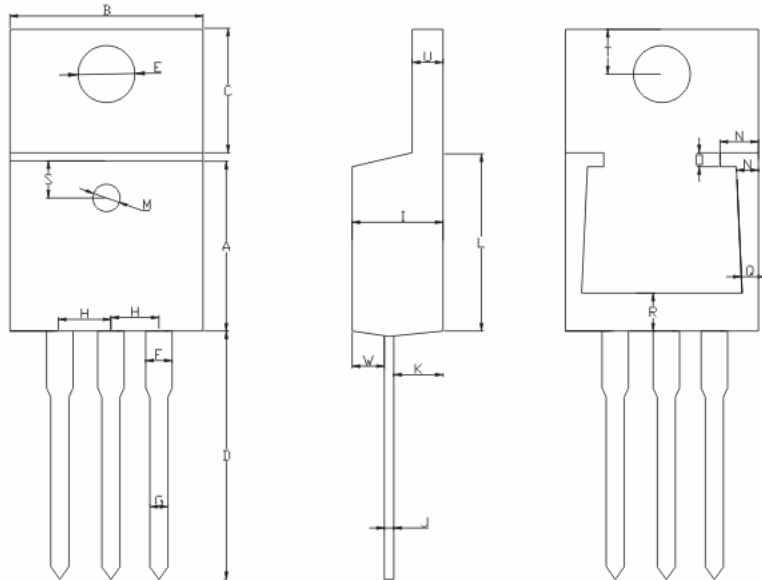


### Mechanical Dimensions: In mm



Symbol	Dimensions in millimeters		
	Min	Typical	Max
A	4.42	4.57	4.72
A1	1.17	1.27	1.37
A2	2.59	2.69	2.89
b	0.71	0.81	0.96
b1		1.27	
c	0.36	0.38	0.61
D	14.94	15.24	15.54
D1	8.85	9.00	9.15
E	10.01	10.16	10.31
e		2.54	
e1		5.06	
H1	6.04	6.24	6.44
L	12.7	13.56	13.78
L1		3.5	
ΦP	3.74	3.84	4.04
Q	2.54	2.74	2.94
Θ1		7°	
Θ2		3°	
Θ3		4°	

### OPTION 1



A: $8.5 \pm 0.5$	B: $9.5 \pm 0.5$	C: $6.4 \pm 0.5$	D: $14.1 \pm 1$
E: $3.84 \pm 0.03$	F: $1.27 \pm 0.03$	G: $0.85 \pm 0.10$	H: $2.54 \pm 0.025$
I: $4.6 \pm 0.5$	J: $0.38 \pm 0.015$	K: $2.75 \pm 0.25$	L: $9.0 \pm 0.5$
M: $1.5 \pm 0.05$	N: $1.8 \pm 0.05$	O: $0.5 \pm 0.05$	P: $1.2 \pm 0.05$
Q: $0.9 \pm 0.05$	R: $3.2 \pm 0.05$	S: $1.55 \pm 0.05$	T: $2.8 \pm 0.15$
U: $1.27 \pm 0.05$	W: $1.27 \pm 0.03$		

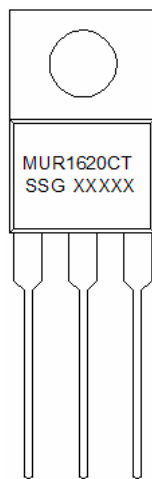
**OPTION 2 (SR)**

**TO-220AB**

Technical Data  
Data Sheet N0305, Rev. -

*Green Products*

**Marking Diagram:**



Where XXXXX is YYWWL

MUR = Device Type  
16 = Forward Current (16A)  
20 = Reverse Voltage (200V)  
CT = Configuration  
SSG = SSG  
YY = Year  
WW = Week  
L = Lot Number

**Cautions:** Molding resin  
Epoxy resin UL:94V-0

**Ordering Information:**

Device	Package	Shipping
MUR1620CT	TO-220AB (Pb-Free)	50pcs / tube

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.



**Maximum Ratings and Electrical Characteristics** @ $T_A=25^{\circ}\text{C}$  unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	MUR1620CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	200	V
Average Rectified Output Current @ $T_A = 55^{\circ}\text{C}$	$I_o$	16.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	125	A
Forward Voltage (per element) @ $I_F = 8.0\text{A}$ , $T_J=25^{\circ}\text{C}$	$V_{FM1}$	0.95	V
Peak Reverse Current @ $T_A = 25^{\circ}\text{C}$ At Rated DC Blocking Voltage @ $T_A = 125^{\circ}\text{C}$	$I_R$	10 500	$\mu\text{A}$
Maximum Reverse Recovery Time (Note 1)	$T_{rr}$	35	ns
Typical Junction Capacitance (Note 2)	$C_J$	80	pF
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	$^{\circ}\text{C}$
Approximate Weight	wt	2.0	g
Case Style	TO-220AB		

Note: 1.Measured with  $I_F=0.5\text{A}$ ;  $I_R=1.0\text{A}$ ;  $I_{RR}=0.25\text{A}$ .  
2.Measured at 1.0MHz and applied reverse voltage of 4.0V D.C.



**Technical Data**  
**Data Sheet N0305, Rev. -**

**Green Products**

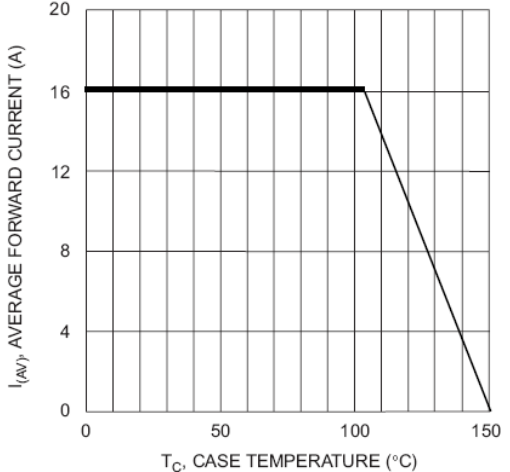


Fig. 1 Forward Current Derating Curve

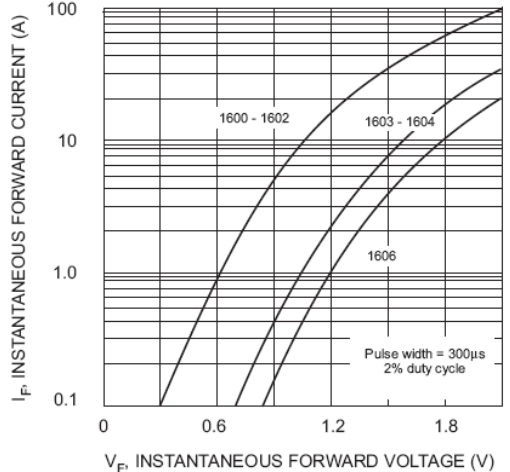


Fig. 2 Typical Forward Characteristics

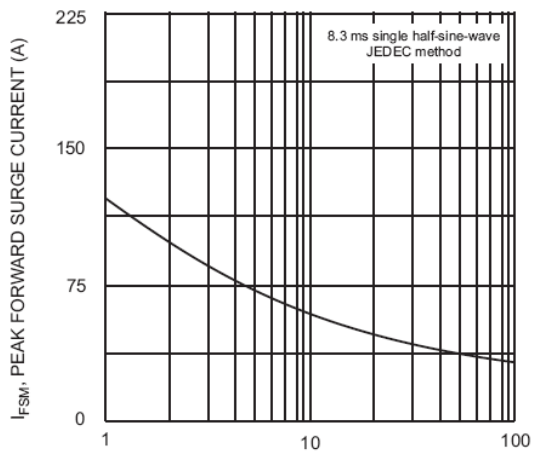


Fig. 3 Maximum Non-Repetitive Surge Current

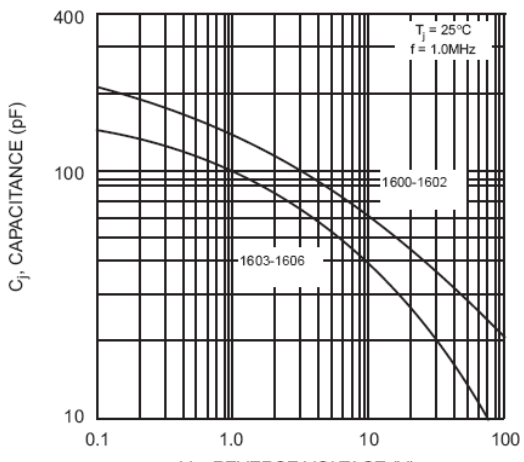
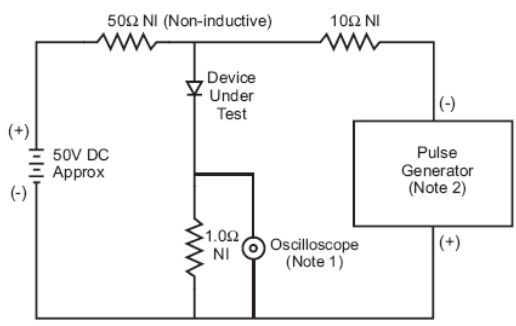


Fig. 4 Typical Junction Capacitance



Notes:  
1. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.  
2. Rise Time = 10ns max. Input Impedance = 50Ω.

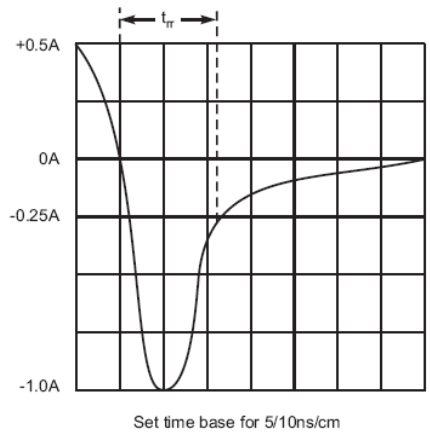


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



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